



RoHS Compliant

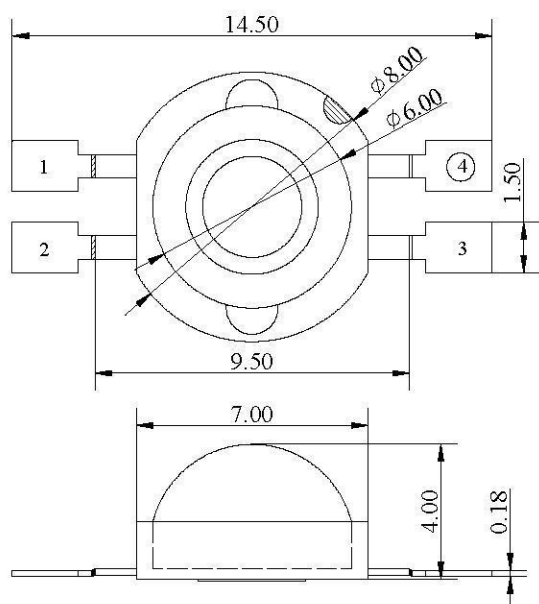
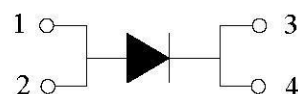
< Features >

- *Excellent Transiting Heat from LED Chip Operating under 1500mA
- *High Luminous Output
- *No UV

< Typical Applications >

- *Reading Lights
- *Portable Flashlight
- *Uplighters and Downlighters
- *Garden lighting
- *LCD Backlights/Light Guides
- *General Lighting

Package Dimensions

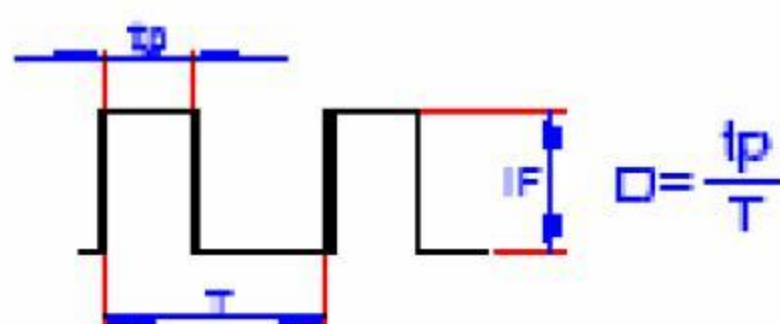


* All dimensions are in mm. *Tolerance : +/-0.25mm.

Absolute Maximum Ratings at Ta=25°C :

Parameter	Rating	Unit
LED Junction Temperature	120	°C
Reverse Voltage	5	V
D.C. Forward Current	1500	mA
Pulsed Forward Current ; $t_p \leq 100\mu s$, Duty cycle=0.005)*1	2000	mA
Operating Temperature Range	-40 to +75	°C
Storage Temperature Range	-40 to +105	°C
Soldering Temperature	Reflow Soldering: 260°C for 10 sec. Hand Soldering: 350°C for 3 sec.	
Electric Static Discharge Threshold (HBM)	6000	V

Duty Cycle :



Notes:

- 1 、 Proper current derating must be observed to maintain junction temperature below the maximum .
- 2 、 All products not sensitive to ESD damage(6000 Volts by HBM condition).
- 3 、 Be careful with a powered up current limited power supply, because of current spikes during power up and/or connection. Best practice is to connect the LED then turn up the voltage gradually. People building their own power supplies should design for minimum current spikes during power up and connection.
- 4 、 For best results the customer needs to provide proper control of the thermal path ,protect against electrical overstress conditions, and ensure that emitters are properly attached to the mcpcb/heat sink.

Characteristics at $I_f=1500\text{mA}$, $V_r=5\text{V}$ ($T_a=25^\circ\text{C}$) :

Parameter		Symbol	Values			Units
			Min.	Typ.	Max.	
Luminous Flux	FULL	Φ_v	147	200	323	lm
	Rank W		147	--	191	
	Rank X		191	--	249	
	Rank Y		249	--	323	
Forward voltage	FULL	VF	2.7	3.3	4.25	V
	Rank V01		2.7	--	3.0	
	Rank V02		3.0	--	3.25	
	Rank V03		3.25	--	3.5	
	Rank V04		3.5	--	3.75	
	Rank V05		3.75	--	4.0	
	Rank V06		4.0	--	4.25	
Correlated Colour Temperature	FULL		5000	6500	9000	° K
	Rank W-1		5000	--	5500	
	Rank W-2		5500	--	6000	
	Rank X-1		6000	--	6500	
	Rank X-2		6500	--	7000	
	Rank Y-1		7000	--	7500	
	Rank Y-2		7500	--	8000	
	Rank Z-1		8000	--	8500	
	Rank Z-2		8500	--	9000	
Thermal Resistance Junction to Case		$R_{\theta_{JC}}$	--	10	--	$^\circ\text{C}/\text{W}$
Temperature Coefficient of Forward Voltage		$\Delta V_F/\Delta T$	--	-2	--	$\text{mV}/^\circ\text{C}$
Reverse Current		I_R	--	--	50	μA
Viewing angle at 50% IV		$2\theta_{1/2}$	--	60	--	Deg.

Notes :

1. Flux is measured with an accuracy of $\pm 15\%$.
2. Forward voltage is measured with an accuracy of $\pm 0.15\text{V}$.
3. CCT selection acc.to CCT groups and an accuracy of $\pm 300^\circ\text{K}$.

Typical Electrical/Optical Characteristic Curves

(25°C Ambient Temperature Unless Otherwise Noted)

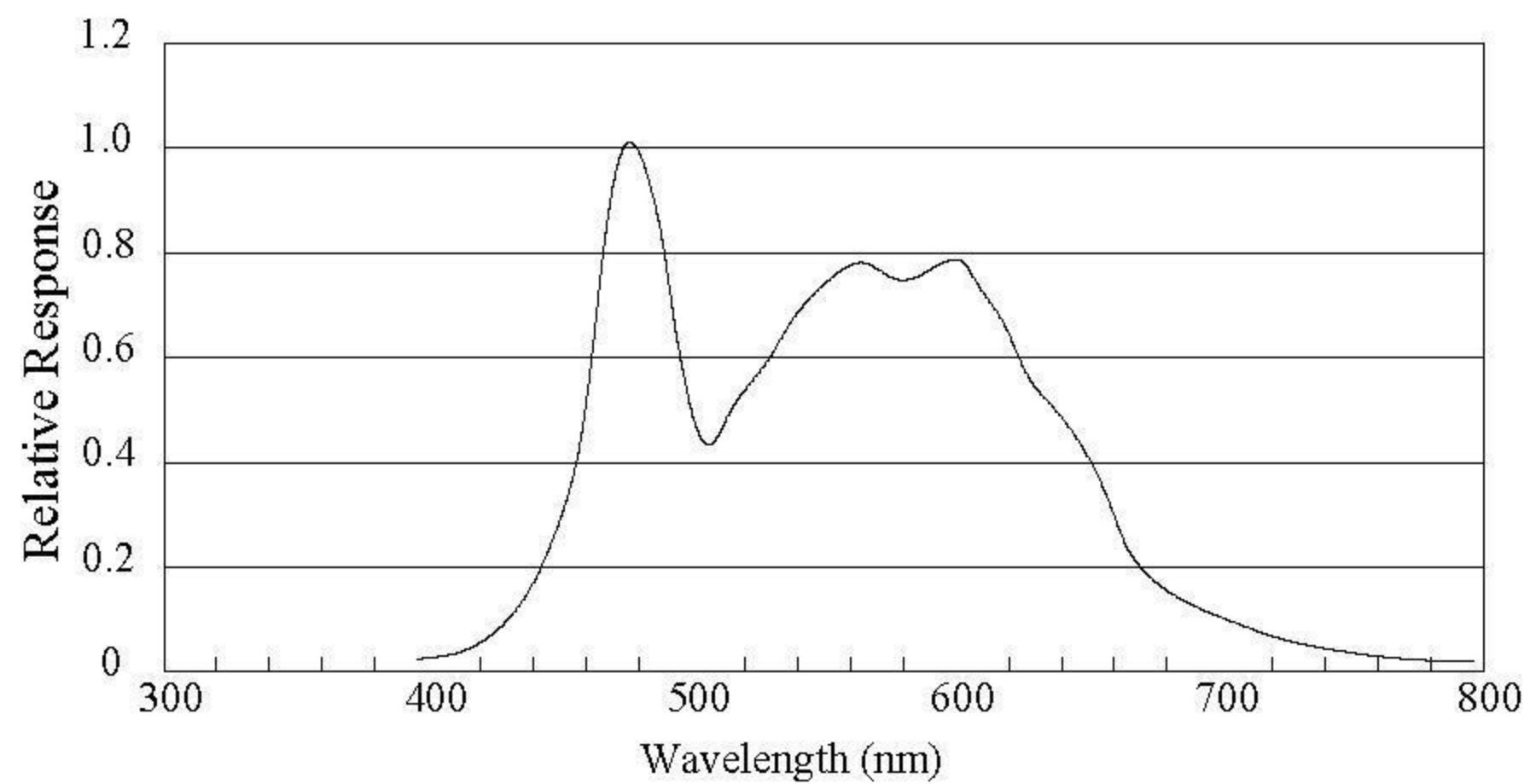
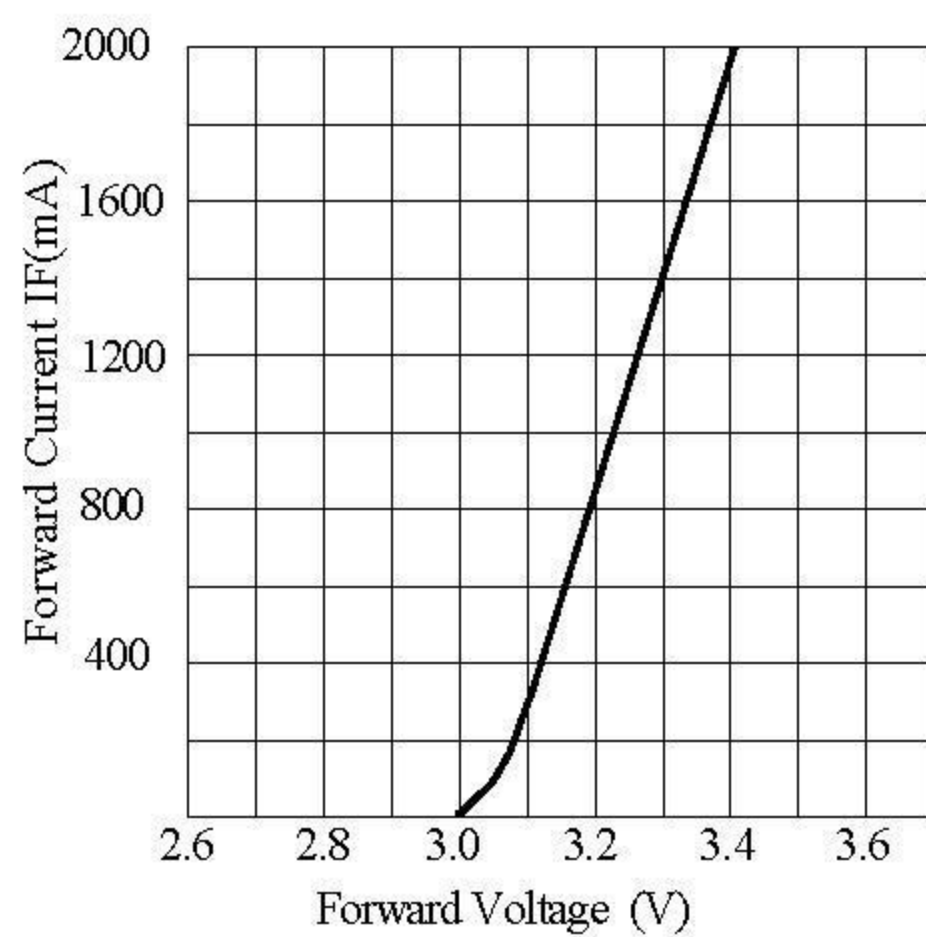
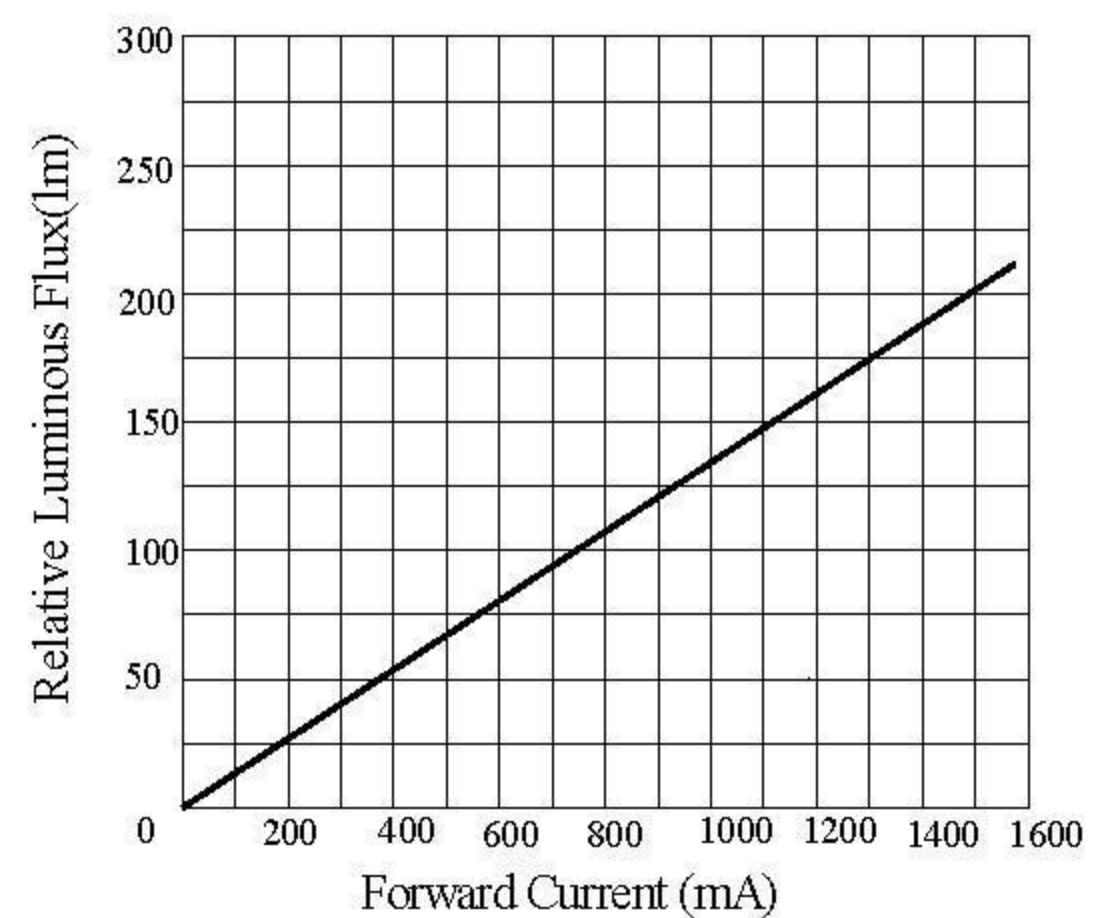


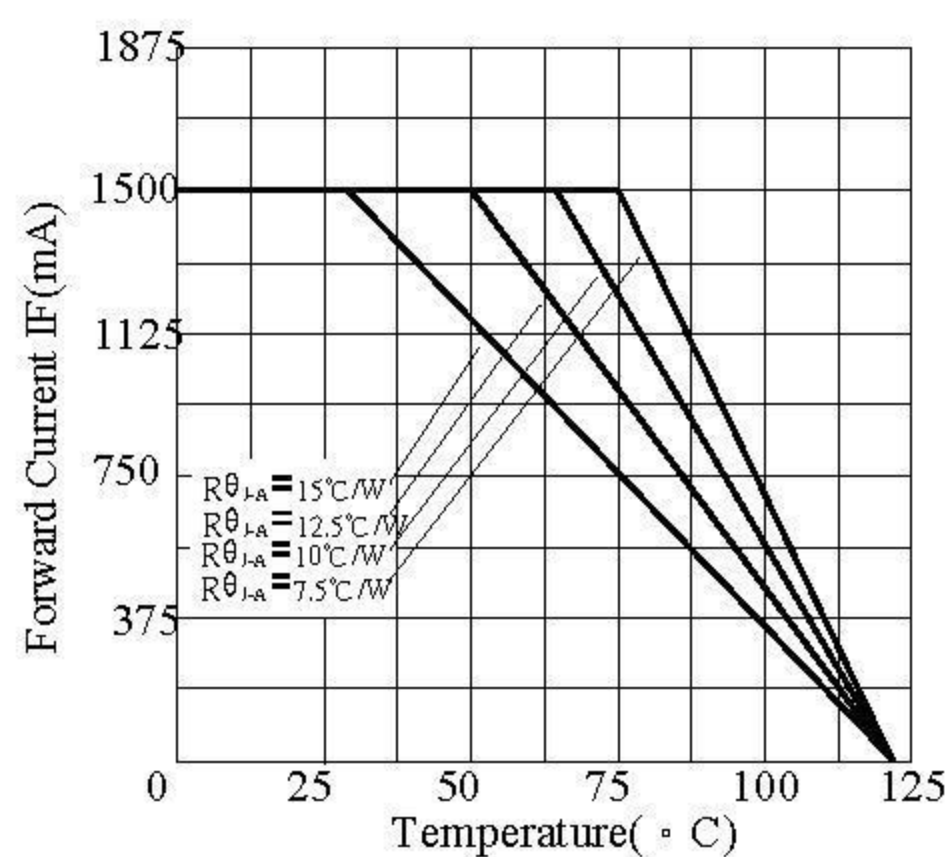
Fig.1 WHITE LED Spectrum VS. WAVELENGTH



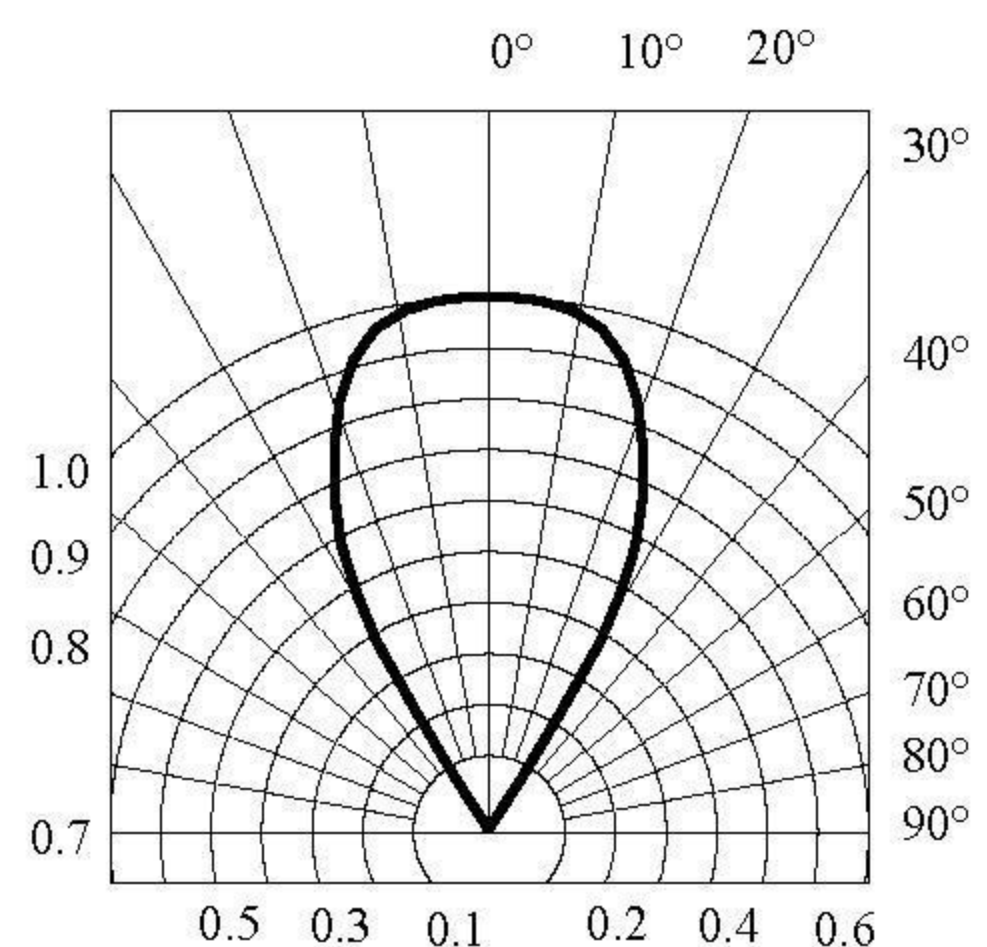
Forward Current VS. Applied Voltage



Forward Current VS. Luminous Flux



Ambient Temperature VS. Forward Current



Radiation Diagram

PRECAUTION IN USE

Storage

Recommended storage environment

Temperature: 5°C ~ 30°C (41°F ~ 86°F)

Humidity: 60% RH Max.

Use within 7 days after opening of sealed vapor/ESD barrier bags.

If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment : 60±5°C for 24 hours.

Fold the opened bag firmly and keep in dry environment.

Soldering

Hand Soldering	
Temperature	350°C Max.
Soldering time	3sec. Max. (one time only)

[Recommended soldering pad design]

Use the following conditions shown in the figure.

